



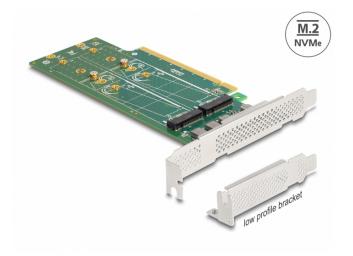
Delock PCI Express 4.0 x16 Card to 4 x internal NVMe M.2 Key M 110 mm - Bifurcation - Low Profile Form Factor

Description

This PCI Express card by Delock expands the PC byfour M.2 slots. Up to four M.2 SSDs in format 22110, 2280 and 2260 can be connected.

PCIe Bifurcation

The card requires the PCle bifurcation of the motherboard to **split the PCle** signal in order to use multiple ports.



Note

Without PCIe bifurcation only the first M.2 slot of the card can be used.

Specification

· Connectors:

internal:

4 x 67 pin M.2 key M slot

1 x PCI Express x16, V4.0

- Interface: PCle
- Supports M.2 modules in format 22110, 2280 and 2260 with key M or key B+M based on PCle (NVMe)
- Maximum height of the components on the module: 1.5 mm, application of doublesided assembled modules supported
- Supports NVM Express (NVMe)
- 4 x LED indicator
- Bootable, ex UEFI version 2.3.1
- Supports S.M.A.R.T.
- Supports TRIM
- Humidity: 15 ~ 90 %
- Operating temperature: 5 °C ~ 50 °C
- Storage temperature: -25 °C ~ 70 °C

System requirements

- Linux Kernel 5.11 or above
- Windows 8.1/8.1-64/10/10-64/11
- Windows Server 2019
- PC with one free PCI Express x16 / x32 slot
- · Motherboard and BIOS with PCIe bifurcation support

Package content

- · PCI Express card
- · Low profile bracket
- User manual

Item no. 90090

EAN: 4043619900909

Country of origin: China

Package: Box



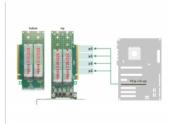


Images













Form factor: Function: Bootable, ex UEFI 2.3.1 TRIM S.M.A.R.T. Supported operating system: Windows 10 32-bit Windows 10 64-bit Windows 8.1 32-bit Windows 8.1 32-bit Windows 8.1 64-bit Windows Server 2019 Windows 11 Linux Kernel 5.11 or above LED indicator: 4 x Maximum height of the components on the module: Interface Internal: 4 x 67 pin M.2 key M slot 1 x PCI Express x16, V4.0 Technical characteristics Operating temperature: 5 °C ~ 50 °C Physical characteristics Iow profile	General	
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